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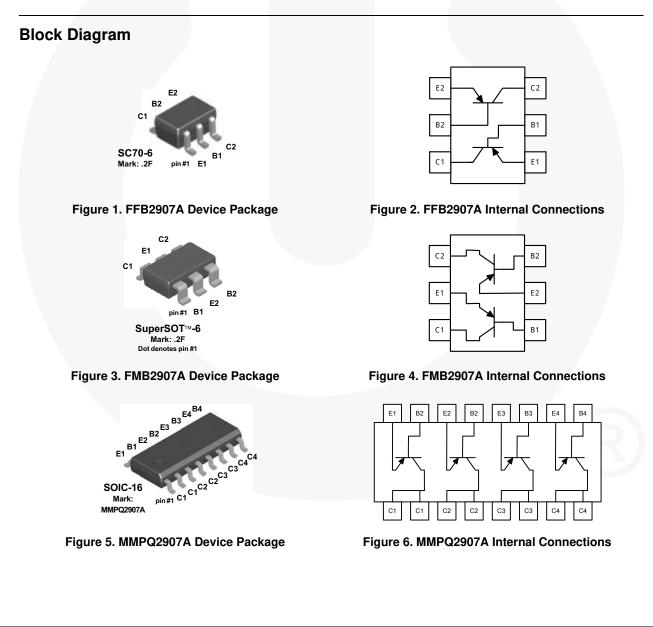




FFB2907A / FMB2907A / MMPQ2907A PNP Multi-Chip General-Purpose Amplifier

Description

This device is designed for use as a general-purpose amplifier and switch for collector currents to 500 mA. Sourced from Process 63.



January 2014

Ordering Information

Part Number	Top Mark	Package	Packing Method
FFB2907A	.2F	SC70 6L	Tape and Reel
FMB2907A	.2F	SSOT 6L	Tape and Reel
MMPQ2907A	MMPQ2907A	SOIC 16L	Tape and Reel

Absolute Maximum Ratings(1),(2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Unit
V _{CEO}	Collector-Emitter Voltage	-60	V
V _{CBO}	Collector-Base Voltage	-60	V
V _{EBO}	Emitter-Base Voltage	-5.0	V
۱ _C	Collector Current - Continuous	-600	mA
T _J , T _{STG}	Junction and Storage Temperature	-55 to +150	°C

Notes:

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty cycle operations.

Thermal Characteristics⁽³⁾

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Sv	mbol	Parameter	Max.			Unit	
Jy	Symbol	Falameter	FFB2907A	FMB2907A	MMPQ2907A	onit	
	Total Device Dissipation		300	700	1,000	mW	
	P _D	Derate Above 25°C	2.4	5.6	8.0	mW/°C	
		Thermal Resistance, Junction to Ambient	415	180			
F	R _{eja}	Thermal Resistance, Junction to Ambient, Effective 4 Die			125	°C/W	
	Thermal Resistance, Junction to Ambient, Each Die			240			

Note:

3. PCB size: FR-4 76 x 114 x 1.57 mm³ (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics⁽⁴⁾

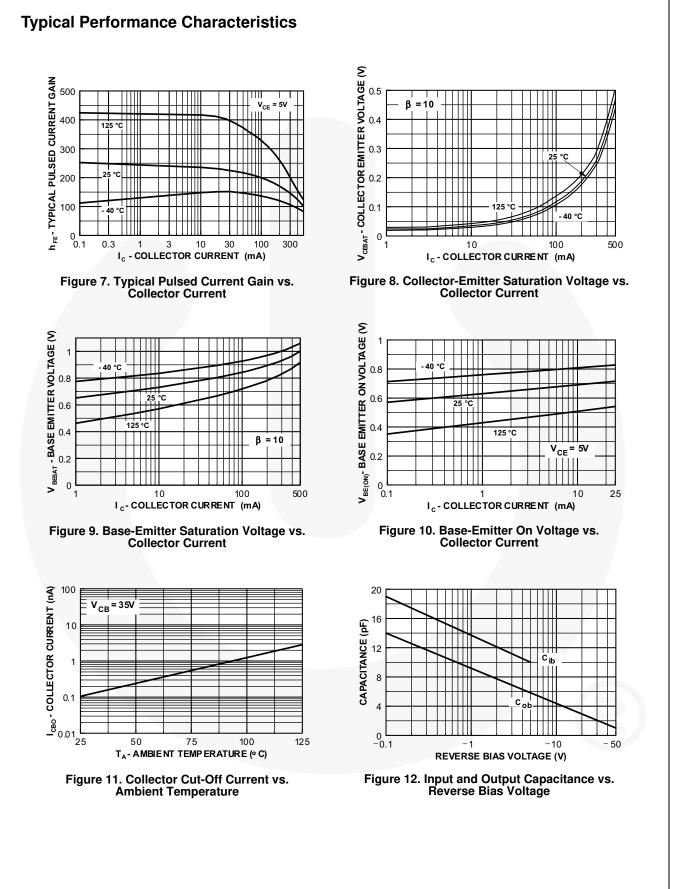
Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage ⁽⁴⁾	I _C = -10 mA, I _B = 0	-60			V	
V _{(BR)CBO}	Collector-Base Breakdown Voltage	I _C = -10 μA, I _E = 0	-60			V	
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	I _E = -10 μA, I _C = 0	-5.0			V	
I _{BL}	Base Cut-Off Current	V_{CE} = -30 V, V_{EB} = -0.5 V			-50	nA	
I _{CEX}	Collector Cut-Off Current	V_{CE} = -30 V, V_{EB} = -0.5 V			-50	nA	
1	Collector Cut-Off Current	$V_{CB} = -50 \text{ V}, \text{ I}_{E} = 0$			-0.02	μA	
I _{CBO}	Collector Cut-On Current	V_{CB} = -50 V, I _E = 0, T _A = 125°C			-20		
		I _C = -0.1 mA, V _{CE} = -10 V	75				
		I _C = -1.0 mA, V _{CE} = -10 V	100				
h _{FE}	DC Current Gain	I _C = -10 mA, V _{CE} = -10 V	100				
		$I_{\rm C}$ = -150 mA, $V_{\rm CE}$ = -10 V ⁽⁴⁾	100		300		
		$I_{\rm C}$ = -500 mA, $V_{\rm CE}$ = -10 V ⁽⁴⁾	50				
	Collector-Emitter Saturation	I _C = -150 mA, I _B = -15 mA			-0.4	-0.4 V	
V _{CE} (sat)	Voltage ⁽⁴⁾	I _C = -500 mA, I _B = -50 mA			-1.6		
V (aat)	Page Emitter Seturation Voltage	I _C = -150 mA, I _B = -15 mA ⁽⁴⁾			-1.3	V	
V _{BE} (sat)	Base-Emitter Saturation Voltage	I _C = -500 mA, I _B = -50 mA			-2.6	V	
f _T	Current Gain-Bandwidth Product	I _C = -50 mA, V _{CE} =- 20 V, f = 100 MHz		250		MHz	
C _{ob}	Output Capacitance	V _{CB} = -10 V, I _E = 0, f = 100 kHz		6.0		pF	
C _{ib}	Input Capacitance	V_{EB} = -2.0 V, I_{C} = 0, f = 100 kHz		12		pF	
t _{on}	Turn-On Time			30		ns	
t _d	Delay Time	V _{CC} = -30 V, I _C = -150 mA, I _{B1} = -15 mA		8		ns	
t _r	Rise Time			20		ns	
t _{off}	Turn-Off Time	V 0.0.V/I 450 1		80		ns	
t _s	Storage Time	V _{CC} = -6.0 V, I _C = -150 mA, I _{B1} = I _{B2} = -15 mA		60		ns	
t _f	Fall Time			20		ns	

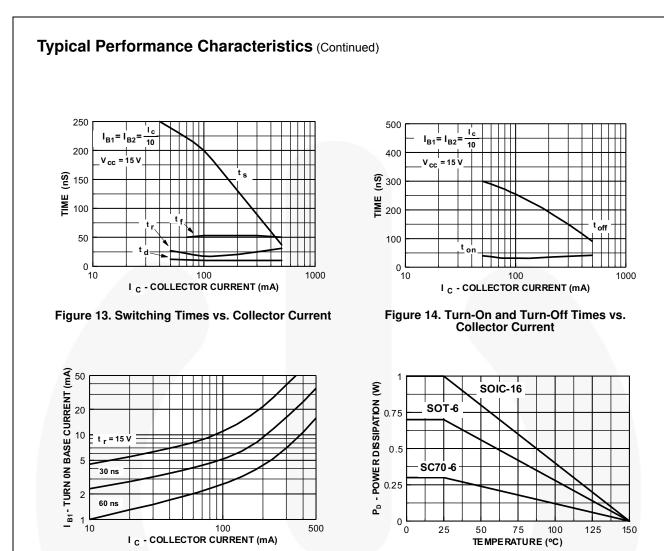
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Note:

4. Pulse test: pulse width ≤ 300 μ s, duty cycle ≤ 2.0%.



4







Typical Performance Characteristics (f = 1.0 kHz)

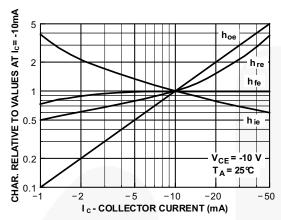


Figure 17. Common Emitter Characteristics

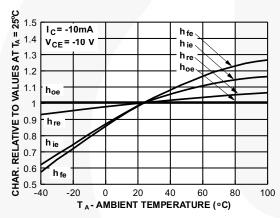


Figure 19. Common Emitter Characteristics

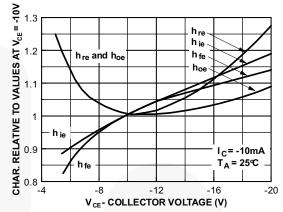
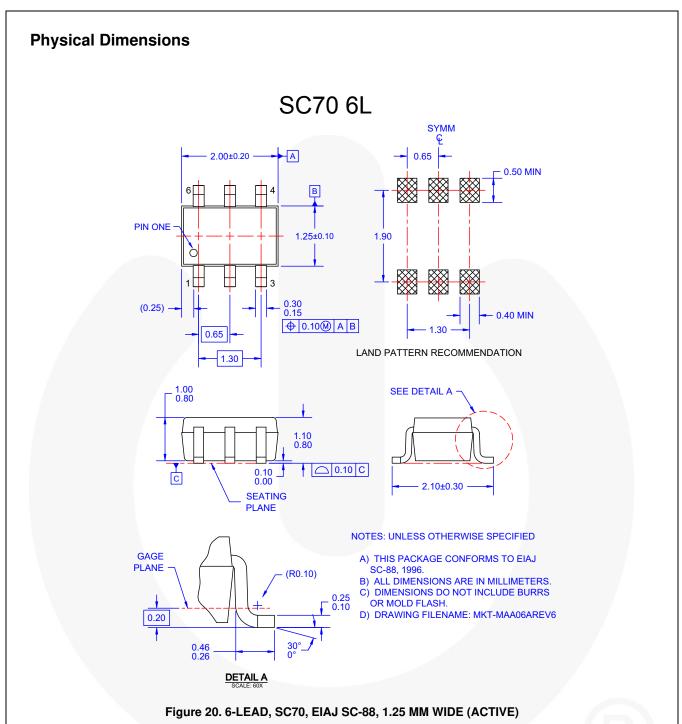


Figure 18. Common Emitter Characteristics



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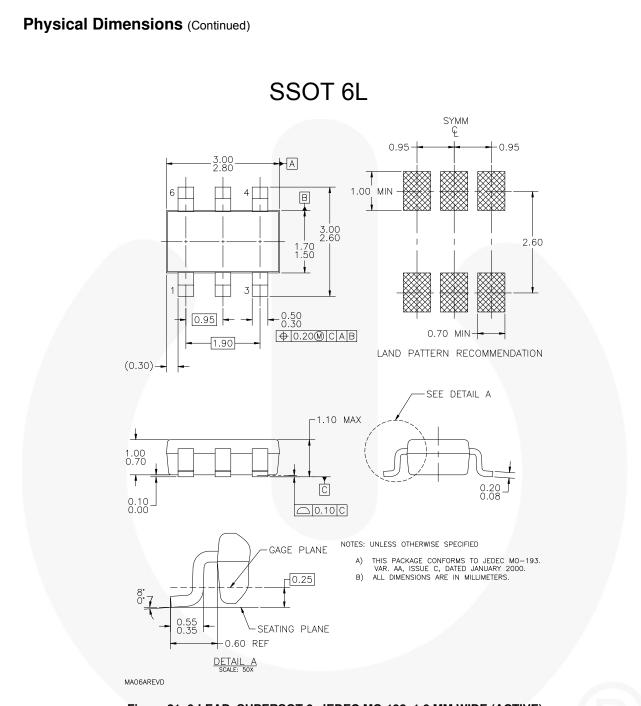


Figure 21. 6-LEAD, SUPERSOT-6, JEDEC MO-193, 1.6 MM WIDE (ACTIVE)

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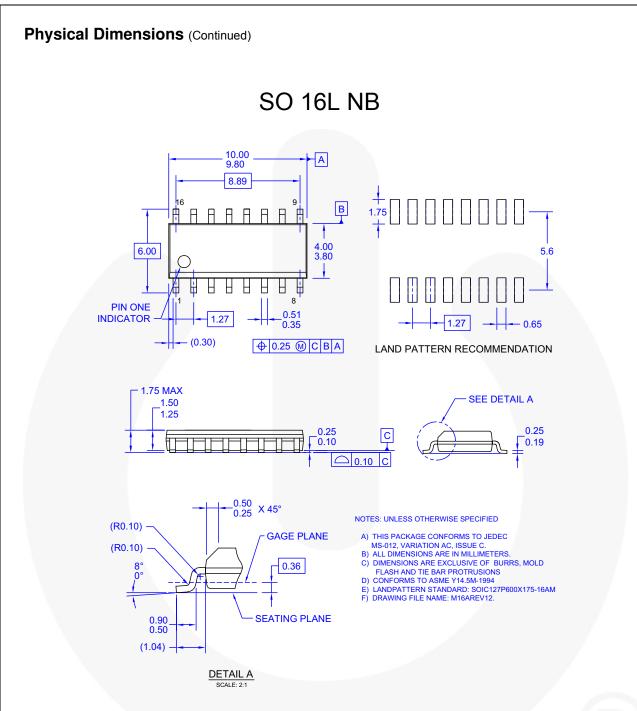


Figure 22. 16-LEAD, SOIC, JEDEC MS-012, 0.150 inch, NARROW BODY (ACTIVE)

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